IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Endou, et al.

Atty. Dkt.: 01-617

Serial No.: Unknown

Group Art Unit:

Filed: Concurrently herewith

Examiner:

Title: METHOD OF MANUFACTURING

SILICON CARBIDE

SEMICONDUCTOR DEVICE

Commissioner for Patents Arlington, VA 22202

Date: April 15, 2004

INFORMATION DISCLOSURE STATEMENT

Sir:

Pursuant to 37 C.F.R. §1.56, the reference(s) listed on the attached Form PTO-1449 is/are submitted for consideration by the Examiner without any admission that it/they constitute(s) statutory prior art, or without any admission that it/they contain(s) subject matter that anticipates the invention or renders the invention obvious to a person of ordinary skill in the art.

The Examiner is requested to initial the attached PTO Form-1449 and to return a copy of same to the undersigned attorney as proof that the listed reference(s) has/have been considered and made of record.

Respectfully submitted,

David G. Posz Reg. No. 37,701

Posz & Bethards, PLC 11250 Roger Bacon Drive, Suite 10 Reston, VA 20190 (703)707-9110 (phone) Customer No. 23400

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		(discussed on page 2 of the specification)		05/15/98	3 JAPAN						X	
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Rev. 10/94 (Form 3.05)